

## DFNWB2\*2-6L-J Plastic-Encapsulate MOSFETS

### CJM1216 P-Channel Power MOSFET

#### DESCRIPTION

The CJM1216 uses advanced trench technology to provide excellent  $R_{DS(on)}$ , low gate charge and operation with low gate voltage.

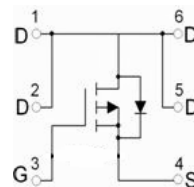
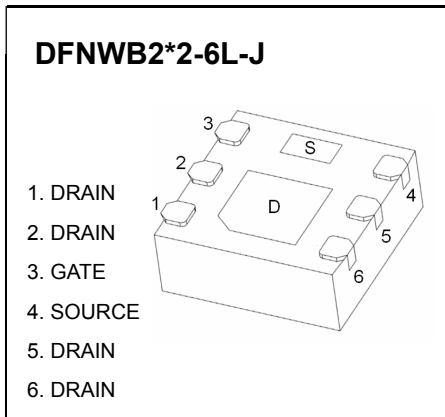
This device is suitable for use as a load switching application and a wide variety of other applications.

#### FEATURES

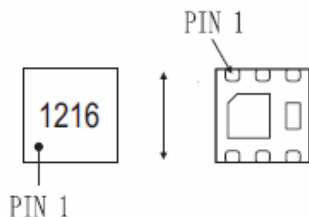
- Advanced trench MOSFET process technology
- Ultra low on-resistance with low gate charge

#### APPLICATIONS

- PWM application
- Load switch
- Battery charge in cellular handset



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#### Maximum ratings ( $T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	-12	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	
Drain Current-Continuous	$I_D$	-16	A
Drain Current-Pulsed (note 1)	$I_{DM}$	-65	
Power Dissipation (note 2, $T_a=25^{\circ}\text{C}$ )	$P_D$	2.5	W
Maximum Power Dissipation (note 3, $T_c=25^{\circ}\text{C}$ )		18	
Thermal Resistance from Junction to Ambient (note 4)	$R_{\theta JA}$	50	$^{\circ}\text{C}/\text{W}$
Thermal Resistance from Junction to Case (note 4)	$R_{\theta JC}$	6.9	
Junction Temperature	$T_j$	150	$^{\circ}\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	

**Electrical characteristics ( $T_a=25^{\circ}\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-12			V
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 8V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -12V, V_{GS} = 0V$			-1	$\mu A$
<b>On Characteristics (note 5)</b>						
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.4	-0.7	-1	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -6.7A$			21	m $\Omega$
		$V_{GS} = -2.5V, I_D = -6.2A$			27	
Forward Transconductance	$g_{fs}$	$V_{DS} = -10V, I_D = -6.7A$		40		S
<b>Dynamic Characteristics (note 6)</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -10V, V_{GS} = 0V, f = 1MHz$		2700		pF
Output Capacitance	$C_{oss}$			680		
Reverse Transfer Capacitance	$C_{rss}$			590		
Total Gate Charge	$Q_g$	$V_{DS} = -6V, V_{GS} = -8V, I_D = -10A$		60	100	nC
				35	48	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -6V, V_{GS} = -4.5V, I_D = -10A$		5		
Gate-Drain Charge	$Q_{gd}$			10		
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Current (note 5)	$I_S$				-16	A
Diode Forward Voltage(note 4)	$V_{SD}$	$V_{GS} = 0V, I_{SD} = -8A$			-1.2	V

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at  $T_a=25^{\circ}\text{C}$ .
3. This test is performed with infinite heat sink at  $T_c=25^{\circ}\text{C}$ .
4. Surface mounted on FR4 board,  $t \leq 10S$ .
5. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
6. Guaranteed by design, not subject to production testing.

# CJM1216

